

Multilayer Ceramic Chip Capacitors

C2012X7T2W223M125AE

Production (NRND)

Product Status Recommended Alternate Part No. : C2012X7T2W223K125AE (Interchangeability is

not guaranteed.)

TDK Item Description C2012X7T2W223MT***S

Commercial Grade **Applications**

Please refer to Part No. CGA4J4X7T2W223M125AE for Automotive use.

MidMid Voltage (100 to 630V) **Feature**

Series C2012 [EIA 0805]

TDK **Brand**

Environmental

Compliance

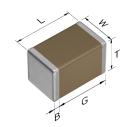




SoftSoft Termination







| | Size |
|-------------------------------|------------------------------------|
| Length(L) | 2.00mm +0.45,-0.20mm |
| Width(W) | 1.25mm +0.25,-0.20mm |
| Thickness(T) | 1.25mm +0.25,-0.20mm |
| Terminal Width(B) | 0.20mm Min. |
| Terminal Spacing(G) | 0.50mm Min. |
| Recommended Land Pattern (PA) | 1.00mm to 1.30mm(Flow Soldering) |
| | 0.90mm to 1.20mm(Reflow Soldering) |
| Recommended Land Pattern (PB) | 1.00mm to 1.20mm(Flow Soldering) |
| | 0.70mm to 0.90mm(Reflow Soldering) |
| Recommended Land Pattern (PC) | 0.80mm to 1.10mm(Flow Soldering) |
| | 0.90mm to 1.20mm(Reflow Soldering) |

| Electrical Characteristics | | |
|------------------------------|---------------|--|
| Capacitance | 22nF ±20% | |
| Rated Voltage | 450VDC | |
| Temperature Characteristic | X7T(+22,-33%) | |
| Dissipation Factor (Max.) | 2.5% | |
| Insulation Resistance (Min.) | 10000ΜΩ | |

| Other | |
|-----------------------|---------------------------------------|
| Operating Temp. Range | -55 to 125°C |
| Soldering Method | Wave (Flow) |
| | Reflow |
| AEC-Q200 | NO |
| Packing | Embossed (Plastic)Taping [180mm Reel] |

[!] Images are for reference only and show exemplary products.

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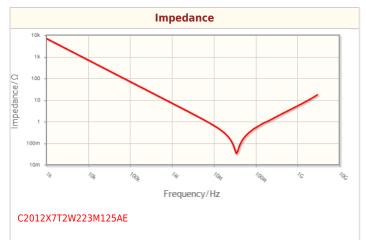
2000pcs Package Quantity

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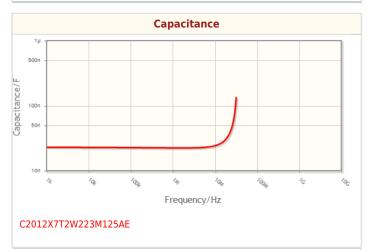
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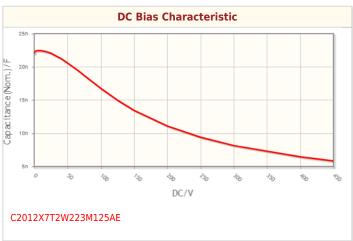
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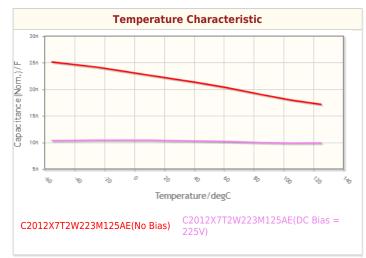
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

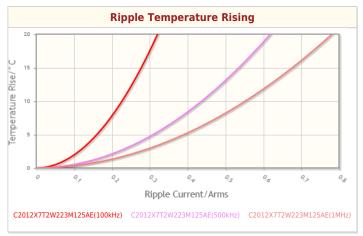












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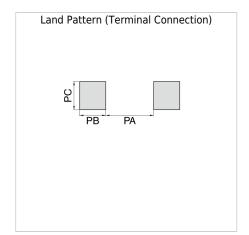
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Associated Images



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